

- Low Loss UHF SAW Filter
- 9.1 x 7.1 mm Version of SF1059A-1
- Single-ended or Balanced Operation
- Complies with Directive 2002/95/EC (RoHS)



Absolute Maximum Ratings

| Rating | Value | Units |
|--|-----------------|-------|
| Maximum Incident Power in Passband | +10 | dBm |
| Maximum DC Voltage Between any 2 Terminals | 30 | VDC |
| Storage Temperature Range | -40 to +85 | °C |
| Suitable for lead-free soldering - Maximum Soldering Profile | 260 °C for 30 s | |

SF1059A

350.0 MHz **SAW Filter**



Electrical Characteristics

| Characteristic | Sym | Notes | Min | Тур | Max | Units |
|---|--|---------|------|--------|------|-------------------|
| Nominal Center Frequency | f _C | 1 | | 350.00 | | MHz |
| Passband: | IL | | | 8 | 10.0 | dB |
| Insertion Loss at fc | | | | | | |
| 3 dB Passband | BW ₃ | 1, 2 | ±400 | ±600 | | kHz |
| Amplitude Variation over fc ±250 kHz | | | | 0.5 | 1.0 | dB _{P-P} |
| Group Delay Variation over fc ±400 kHz | GDV | | | 200 | 250 | ns _{P-P} |
| Rejection referenced to IL: | | 1, 2, 3 | 35 | 40 | | |
| (fc - 8.0) to (fc - 2.0) and (fc + 2.0) to (fc + 8.0) MHz | | | | | | dD |
| (fc - 50) to (fc - 8.0) and (fc + 8.0) to (fc + 50) MHz | | | 40 | 45 | | UD |
| Ultimate Rejection | | | | 50 | | |
| Operating Temperature Range | T _A | 1 | -20 | | +70 | °C |
| Impedance Matching to 50 Ω unbalanced | External L-C | | | | | |
| Case Style | SM9171-10 9.1 x 7.1 mm Nominal Footprint | | | | | |
| Lid Symbolization (YY=year, WW=week, S=shift, ##=sequence code) | RFM SF1059A YYWWS## | | | | | |

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

NOTES:

- 1. Unless noted otherwise, all specification apply over the operating temperature range with filter soldered to the specified demonstration board with impedanced matching to 50 Ω network analyzer.
- 2. 3.

Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.

- 4 "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- 5. The design, manufacturing process, and specifications of this filter are subject to change.
- 6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- US and international patents may apply. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd. 7. 8.

SF1059A Filter Plots



SF1059A Impedance Plots





SF1059A Typical Tuning Network



SM9171-10 Case

10-Terminal Ceramic Surface-Mount Case 9.1 x 7.1 mm Nominal Footprint



| Case Dimensions | | | | | | |
|-----------------|------|------|--------|-------|-------|-------|
| Dimension | mm | | Inches | | | |
| | Min | Nom | Мах | Min | Nom | Max |
| Α | 8.86 | 9.09 | 9.40 | 0.349 | 0.358 | 0.370 |
| В | 6.88 | 7.11 | 7.40 | 0.271 | 0.280 | 0.291 |
| С | | 1.91 | 2.00 | | 0.075 | 0.079 |
| D | | 0.99 | | | 0.039 | |
| E | | 0.79 | | | 0.031 | |
| н | | 1.0 | | | 0.039 | |
| Р | | 2.54 | | | 0.100 | |

| Materials | | | | |
|-----------------------|--|--|--|--|
| Solder Pad Plating | 0.3 to 1.0 µm Gold over 1.27 to 8.89 µm Nickel | | | |
| Lid Plating | 2.0 to 3.0 µm Nickel | | | |
| Body | Al ₂ O ₃ Ceramic | | | |
| Pb Free | | | | |

| Electrical Connections | | | | |
|----------------------------|------------------|-------------|--|--|
| | Connection | Terminals | | |
| Port 1 | Input or Return | 5 | | |
| | Return or Input | 6 | | |
| Port 2 | Output or Return | 10 | | |
| | Return or Output | 1 | | |
| | Ground | All others | | |
| For Single-ended Operation | | Ground 1, 6 | | |

